505867540 01/16/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ERIK NINO MERCADO TOLENTINO	01/16/2020
SHUTESH KRISHNAN	01/16/2020
FRANCIS J. CARNEY	01/08/2020

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC	
Street Address:	5005 E. MCDOWELL ROAD	
Internal Address:	MAILDROP A700	
City:	PHOENIX	
State/Country:	ARIZONA	
Postal Code:	85008	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16744378

CORRESPONDENCE DATA

Fax Number: (602)244-3169

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6022443574

Email: patents@onsemi.com

Correspondent Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC

Address Line 1: 5005 E. MCDOWELL ROAD

Address Line 2: MAILDROP A700

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ATTORNEY DOCKET NUMBER:	ONS03649US	
NAME OF SUBMITTER:	SHARRON CASTILLO	
SIGNATURE:	/Sharron Castillo/	
DATE SIGNED:	01/16/2020	

Total Attachments: 4

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PATENT 505867540 REEL: 051532 FRAME: 0521

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PATENT REEL: 051532 FRAME: 0522 For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name

of (City and State OR Country)

ERIK NINO MERCADO TOLENTINO SHUTESH KRISHNAN

NEGERI SEMBILAN, SEREMBAN MALAYSIA

NEGERI SEMBILAN MALAYSIA

FRANCIS J. CARNEY

MESA, ARIZONA US

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

Title: DIRECT BONDED COPPER SUBSTRATES FABRICATED USING SILVER SINTERING

Attorney Docket No.: ONS03649US

Serial No.: 16/744378

Filing Date: January 16, 2020

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

By (Inventor signature): Erik Nino Mercado Tolentino	
Witnessed by (Witness signature);	
Printed name of Witness: WANG SOON WE!	
Signed and Witnessed on this day of JAN	, 2020

By (Inventor signature):	
Shutesh Krishnan	
Witnessed by (Witness signature): Way	
Printed name of Witness: WANG SOON WEI	
Signed and Witnessed on this day of month	2020
doy monn	, cui

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name of (City and State OR Country)

ERIK NINO MERCADO TOLENTINO

NEGERI SEMBILAN, SEREMBAN MALAYSIA

SHUTESH KRISHNAN

NEGERI SEMBILAN MALAYSIA

FRANCIS J. CARNEY

MESA, ARIZONA US

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Francis J. Carney

ACKNOWLEDGMENT

State of Arizona

County of Maricopa

On this day of day of 2020, before me personally appeared, Francis J Carney, whose identity was proven to me on the basis of satisfactory evidence to be the person who he/she claims to be, and acknowledged that he/she signed the above/attached document.

(seal)

SHARRON CASTILLO
Notary Public, State of Arizona
Maricape County
Commission # 681584
My Commission Expires
March 28, 2023

Netary Public

RECORDED: 01/16/2020